

FUJITSU

ECL 4096-BIT BIPOLAR RANDOM ACCESS MEMORY

MBM 10474A-5
MBM 10474A-7

June 1987
Edition 1.0

4096-BIT BIPOLAR ECL RANDOM ACCESS MEMORY

The Fujitsu MBM 10474A is fully decoded 4096-bit ECL read/write random access memory designed for high-speed scratch pad, control and buffer storage applications. This device is organized as 1024 words by 4 bits, and it features on-chip voltage compensation for improved noise margin.

The MBM 10474A offers extremely small cell and chip size, realized through the use of Fujitsu's patented DOPOS (Doped Polysilicon), as well as U-Fox (U-groove isolation with thick field oxide) processing. As a result, very fast access time with high yields and outstanding device reliability are achieved in volume production.

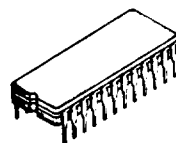
Operation for the MBM 10474A is specified over a temperature range of from 0° to 75°C (T_A for DIP, T_C for Flat Package and LCC). It also features 24-pin DIP, Flat Package, or LCC. It is fully compatible with industry-standard 10 K-series ECL families.

- 1024 words x 4 bits organization
- On-chip voltage compensation for improved noise margin
- Fully compatible with industry-standard 10 K-series ECL families
- Address access time: 5 ns max. (MBM 10474A-5)
7 ns max. (MBM 10474A-7)
- Chip select access time: 3 ns max. (MBM 10474A-5)
5 ns max. (MBM 10474A-7)
- Open emitter output for ease of memory expansion
- Low power dissipation of 0.33 mW/bit typ. (MBM 10474A-5)
0.24 mW/bit typ. (MBM 10474A-7)
- DOPOS and U-Fox processing
- Pin compatible with the F10474

ABSOLUTE MAXIMUM RATINGS (See NOTE)

Rating	Symbol	Value	Unit
V_{EE} Pin Potential to Ground Pin	V_{EE}	+0.5 to -7.0	V
Input Voltage	V_{IN}	+0.5 to V_{EE}	V
Output Current (DC, Output High)	I_{OUT}	-30	mA
Temperature under Bias	T_A for DIP	-55 to +125	°C
	T_C for Flat Package and LCC	-55 to +125	
Storage Temperature	T_{STG}	-65 to +150	°C

NOTE: Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet.



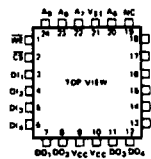
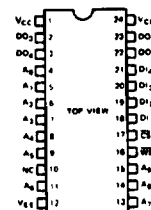
CERAMIC PACKAGE
DIP-24C-C05



CERAMIC PACKAGE
FPT-24C-C02

LCC-24C-F02: See page 10

PIN ASSIGNMENT

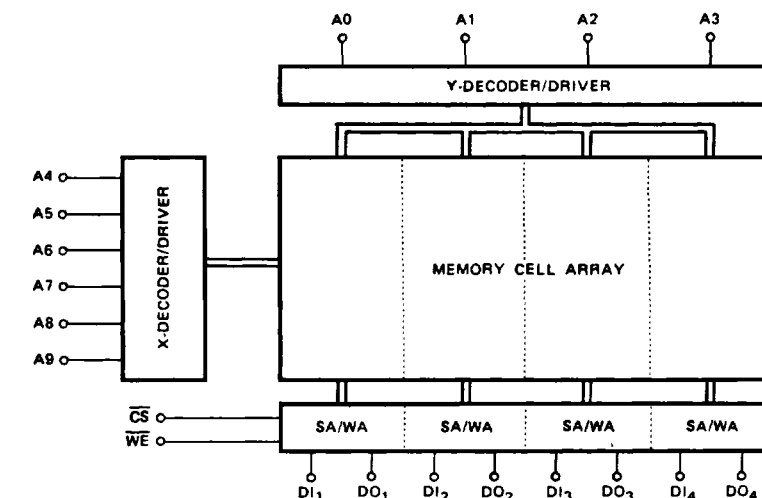


V_{CC} grounded
LCC PAD CONFIGURATION : See page 10

Small geometry bipolar integrated circuits are occasionally susceptible to damage from static voltages or electric fields. It is therefore advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this device.

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Fig. 1 – MBM 10474A BLOCK DIAGRAM



TRUTH TABLE

INPUT			OUTPUT	MODE
$\overline{CS}$	$\overline{WE}$	D_{IN}		
H	X	X	L	DISABLED
L	L	H	L	WRITE "H"
L	L	L	L	WRITE "L"
L	H	X	D_{OUT}	READ

H = High Voltage Level
 L = Low Voltage Level
 X = Don't care

FUNCTIONAL DESCRIPTION

The Fujitsu MBM 10474A is fully decoded 4096-bit read/write random access memory organized as 1024 words by 4 bits. Memory cell selection is achieved by means of a 10-bit address designated A_0 through A_9 . The active low Chip Select ($\overline{CS}$) input is provided for memory expansion. The read and write operations are controlled by the state of the active low

Write Enable ($\overline{WE}$) input. With $\overline{WE}$ and $\overline{CS}$ held low, the data at D_{IN} is written into the addressed location. To read, $\overline{WE}$ is held high, while $\overline{CS}$ is held low. Data at the addressed location is then transferred to D_{OUT} and read out non-inverted. Open emitter outputs are provided to allow for maximum flexibility in output wired-OR connection.

GUARANTEED OPERATING CONDITIONS

(Referenced to V_{CC})

Parameter	Symbol	Min	Typ	Max	Unit	Ambient Temperature for DIP, Case Temperature for Flat Package and LCC
Supply Voltage	V_{EE}	-5.46	-5.2	-4.94	V	0°C to 75°C

DC CHARACTERISTICS

($V_{CC} = 0$ V, $V_{EE} = -5.2$ V, Output Load = $50\ \Omega$ to -2.0 V, $T_A = 0^\circ\text{C}$ to 75°C for DIP, Airflow ≥ 2.5 m/s, $T_C = 0^\circ\text{C}$ to 75°C for Flat Package and LCC, unless otherwise noted.)

Parameter	Symbol	Min	Typ	Max	Unit	T_A
Output High Voltage ($V_{IN} = V_{IH\ max}$ or $V_{IL\ min}$)	V_{OH}	-1000 -960 -900		-840 -810 -720	mV	0°C 25°C 75°C
Output Low Voltage ($V_{IN} = V_{IH\ max}$ or $V_{IL\ min}$)	V_{OL}	-1870 -1850 -1830		-1665 -1650 -1625	mV	0°C 25°C 75°C
Output High Voltage ($V_{IN} = V_{IH\ min}$ or $V_{IL\ max}$)	V_{OHC}	-1020 -980 -920			mV	0°C 25°C 75°C
Output Low Voltage ($V_{IN} = V_{IH\ min}$ or $V_{IL\ max}$)	V_{OLC}			-1645 -1630 -1605	mV	0°C 25°C 75°C
Input High Voltage (Guaranteed Input Voltage High for All Inputs)	V_{IH}	-1145 -1105 -1045		-840 -810 -720	mV	0°C 25°C 75°C
Input Low Voltage (Guaranteed Input Voltage Low for All Inputs)	V_{IL}	-1870 -1850 -1830		-1490 -1475 -1450	mV	0°C 25°C 75°C
Input High Current ($V_{IN} = V_{IH\ max}$)	I_{IH}			220	μA	0°C to 75°C
Input Low Current ($V_{IN} = V_{IL\ min}$)	I_{IL}	-50			μA	0°C to 75°C
$\overline{\text{CS}}$ Input Low Current ($V_{IN} = V_{IL\ min}$)	I_{IL}	0.5		170	μA	0°C to 75°C
Power Supply Current (All Inputs and Outputs Open)	I_{EE}	MBM 10474A-5	-300		mA	0°C to 75°C
		MBM 10474A-7	-220			

CAPACITANCE

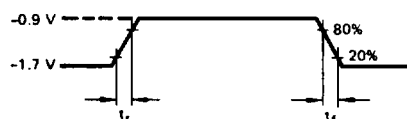
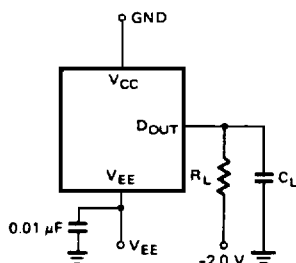
Parameter	Symbol	Min	Typ	Max	Unit
Input Pin Capacitance	C_{IN}		4	5	pF
Output Pin Capacitance	C_{OUT}		5	6	pF



AC CHARACTERISTICS

($V_{CC} = 0\text{ V}$, $V_{EE} = -5.2\text{ V} \pm 5\%$, Output Load = $50\ \Omega$ to -2.0 V and 30 pF to GND, $T_A = 0^\circ\text{C}$ to 75°C for DIP, Airflow $\geq 2.5\text{ m/s}$, $T_C = 0^\circ\text{C}$ to 75°C for Flat Package and LCC, unless otherwise noted.)

Fig. 2 – AC TEST CONDITIONS



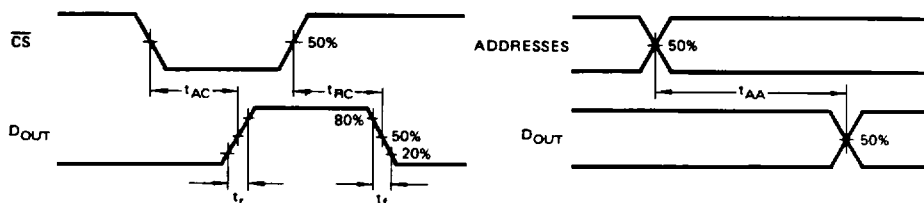
Output Load: $R_L = 50\ \Omega$
 $C_L = 30\text{ pF}$
(including jig and stray capacitance)

NOTE: All timing measurements referenced to 50% input levels.

READ CYCLE

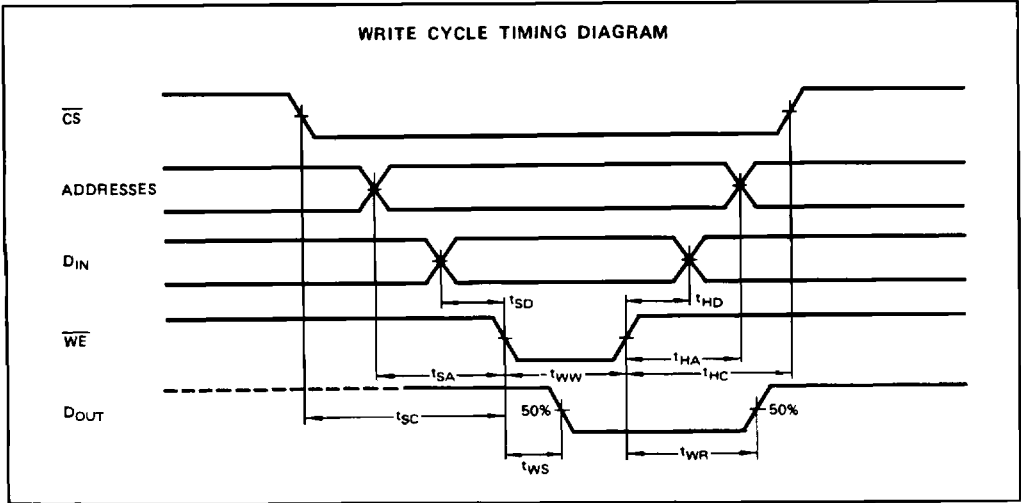
Parameter	Symbol	MBM 10474A-5			MBM 10474A-7			Unit
		Min	Typ	Max	Min	Typ	Max	
Address Access Time	t_{AA}	1.2		5	1.2		7	ns
Chip Select Access Time	t_{AC}	0.5		3	0.5		5	ns
Chip Select Recovery Time	t_{RC}	0.5		3	0.5		5	ns

READ CYCLE TIMING DIAGRAMS



WRITE CYCLE

Parameter	Symbol	MBM 10474A-5			MBM 10474A-7			Unit
		Min	Typ	Max	Min	Typ	Max	
Write Pulse Width	t _{WW}	8			5			ns
Write Disable Time	t _{WS}	0.3		3	0.3		6.5	ns
Write Recovery Time	t _{WR}	0.5		7	0.5		8	ns
Address Set Up Time	t _{SA}	1			1			ns
Chip Select Set Up Time	t _{SC}	0			0			ns
Data Set Up Time	t _{SD}	0			0			ns
Address Hold Time	t _{HA}	1			1			ns
Chip Select Hold Time	t _{HC}	1			1			ns
Data Hold Time	t _{HD}	1			1			ns



RISE TIME and FALL TIME

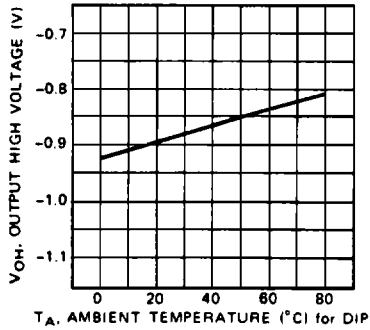
Parameter	Symbol	Min	Typ	Max	Unit
Output Rise Time	t _r		1.5		ns
Output Fall Time	t _f		1.5		ns



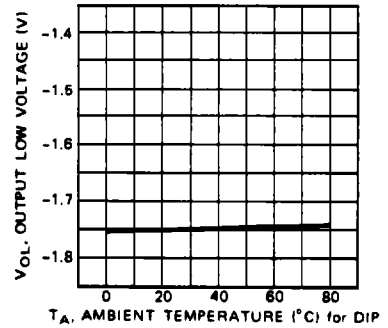
FUJITSU MBM 10474A-5
MBM 10474A-7

CHARACTERISTICS CURVES

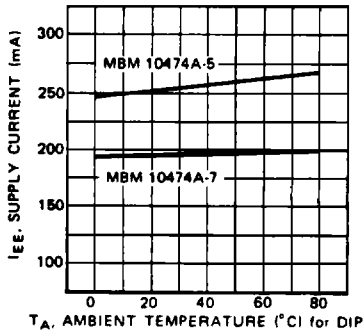
**Fig. 3 – OUTPUT HIGH VOLTAGE
vs AMBIENT TEMPERATURE**



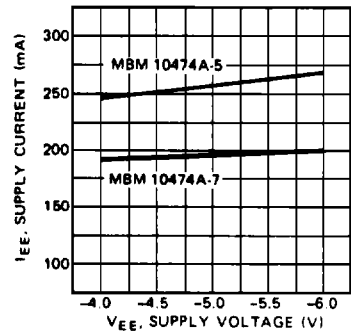
**Fig. 4 – OUTPUT LOW VOLTAGE
vs AMBIENT TEMPERATURE**

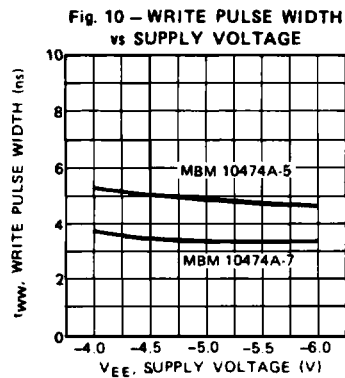
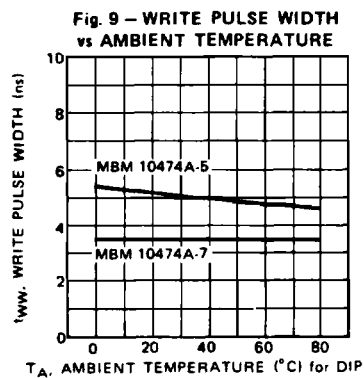
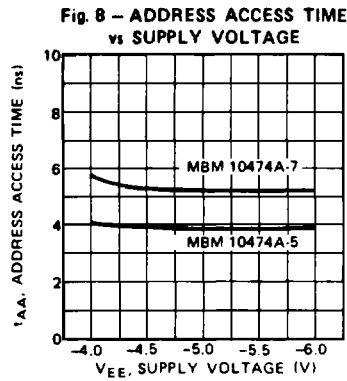
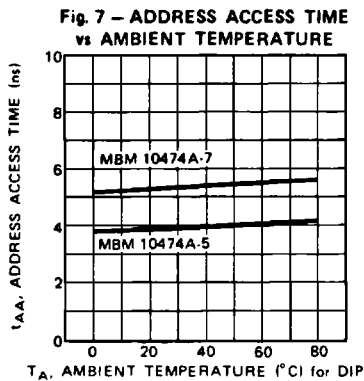


**Fig. 5 – SUPPLY CURRENT
vs AMBIENT TEMPERATURE**

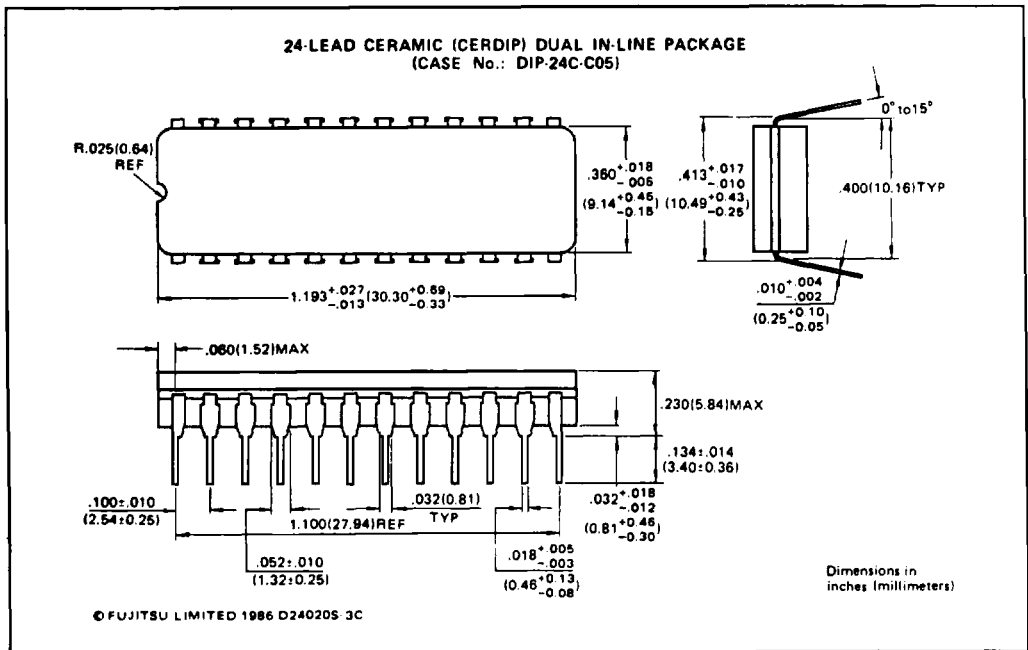


**Fig. 6 – SUPPLY CURRENT
vs SUPPLY VOLTAGE**





PACKAGE DIMENSIONS



24-LEAD CERAMIC AXIAL FLAT PACKAGE
(CASE No.: FPT-24C-C02)

Top View Dimensions:

- Pin pitch (left): $.375^{+.025}_{-.005}$ (9.53 $^{+0.64}_{-0.13}$)
- Pin pitch (right): $.343^{+.017}_{-.010}$ (8.71 $^{+0.43}_{-0.25}$)
- Pin width (left): $.050(1.27)$ TYP
- Pin width (right): $.075(1.91)$ MAX
- Pin thickness: $.017 \pm .001$ (0.43 ± 0.03)
- Reference dimension (left): $.250(6.35)$ REF
- Overall width: $1.066(27.08)$ MIN

Side View Dimensions:

- Overall height: $1.066(27.08)$ MIN
- Pin height: $.375^{+.025}_{-.005}$ (9.53 $^{+0.64}_{-0.13}$)
- Pin thickness: $.343^{+.017}_{-.010}$ (8.71 $^{+0.43}_{-0.25}$)

Detail View Dimensions:

- Pin thickness: $.005^{+.003}_{-.001}$ (0.13 $^{+0.08}_{-0.03}$)
- Pin width: $.038 \pm .008$ (0.97 ± 0.20)

PIN NO. 1 INDEX

Dimension in inches and (millimeters)

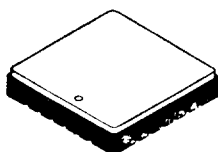
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MBM 10474A-7

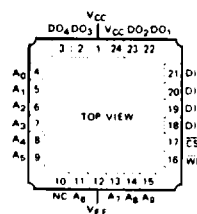
PACKAGE DIMENSIONS

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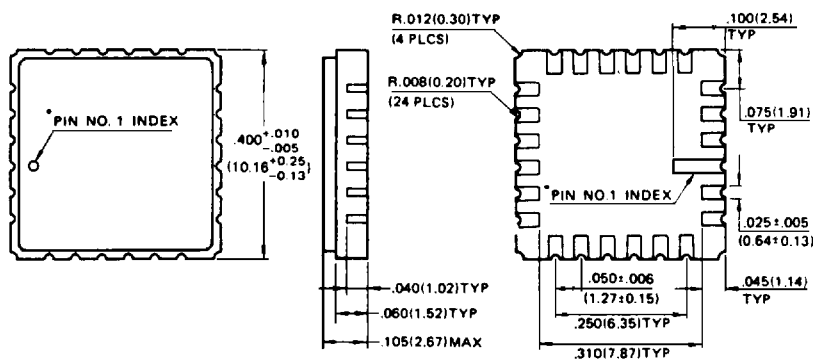


LCC-24C-F02

PAD CONFIGURATION



24-PAD CERAMIC (FRIT SEAL) LEADLESS CHIP CARRIER (CASE No.: LCC-24C-F02)



* Shape of PIN NO. 1 INDEX: Subject to change without notice.

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Dimensions in inches
(millimeters)